













- ► Ceramic High Power
- ➤ 3535 2.22t Series
- ➤ Yellow (590nm)

N0Y09S81





3535 2.22t Series





FEATURES:

Package: Ceramic SMT Package with Silicon Lens

Forward Current: 350~700mA Forward Voltage (typ.): 2.1V

Luminous Flux (typ.): 55lm@350Ma

Colour: Yellow Wavelength: 590nm Viewing angle: 120°

Materials:

Die: AlGaInP

Resin: Silicon (Water Clear)

L/T Finish: Ag plated Operating Temperature: -40~+85°C

Storage Temperature: -40~+100°C

Grouping parameters:

Forward Voltage

Luminous Flux

Dominant Wavelength

Soldering methods: Reflow

Preconditioning: MSL2 according to J-STD020

Packing: 12mm tape with Min.100pcs /reel, ø180mm (7")

APPLICATIONS:

- **Decorative Lighting**
- Portable Lighting
- **Outdoor Lighting**
- **Commercial Lighting Indoor Lighting**
- **Industrial Lighting**



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	IF	700	mA
Pulse Forward Current D=0.01S; duty 1/10	IPF	1000	mA
Reverse Voltage	V _R	5	V
Reverse Current @5V	I _R	10	μΑ
Junction Temperature	Tj	150	°C
Electrostatic Discharge (HBM: MIL-STD-883 C 3B)	ESD	8000	V
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	Tstg	-40~+100	°C
Soldering Temperature	T _{SOL}	250	°C

Electrical & Optical Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Test
Parameter	Зуппоп	Min.	Тур.	Max.	Offic	Condition
Forward Voltage	V_{F}	1.8		2.4	V	I _F =350mA
Luminous Flux	Ф۷	45	55	65	lm	I _F =350mA
Dominant Wavelength	λD	585		595	nm	I _F =350mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =350mA

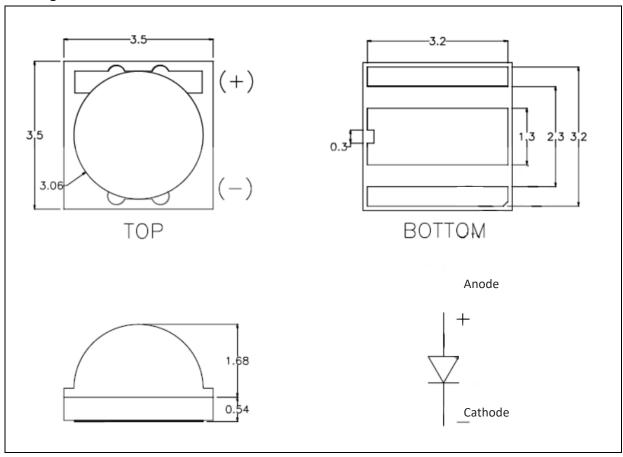
^{1.} Luminous flux (Φ_V) ±7%, Forward Voltage (V_F) ±0.05V, Viewing angle($2\theta_{1/2}$) ±10°

^{2.} IS standard testing



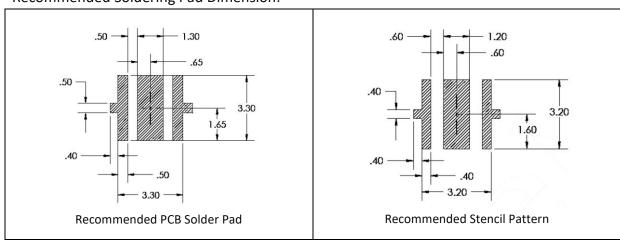
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.12mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 350mA):

Code	Min.	Max.	Unit
V1820	1.8	2.0	
V2022	2.0	2.2	V
V2224	2.2	2.4	

Luminous Flux Classifications (I_F = 350mA):

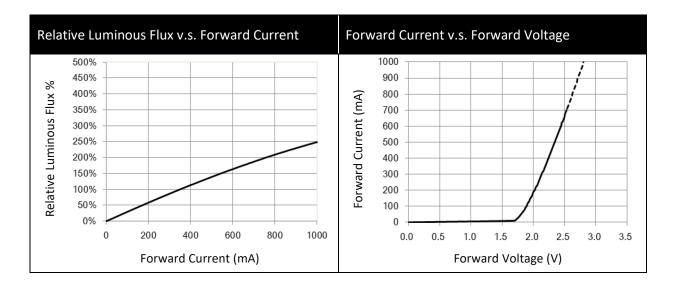
Code	Min.	Max.	Unit
B24	45	50	
B25	50	55	lun
B26	55	60	lm
B27	60	65	

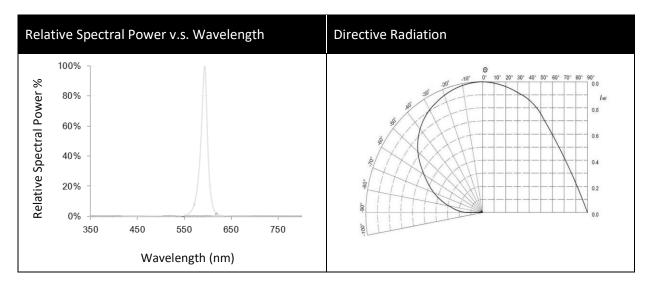
Dominant Wavelength Classifications (IF = 350mA):

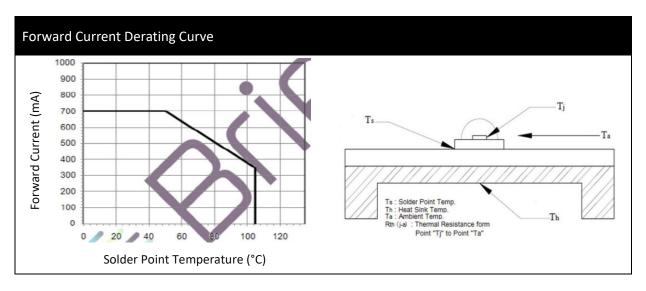
Code	Min.	Max.	Unit
Y585	585	590	
Y590	590	595	nm



ELECTRO-OPTICAL CHARACTERISTICS:



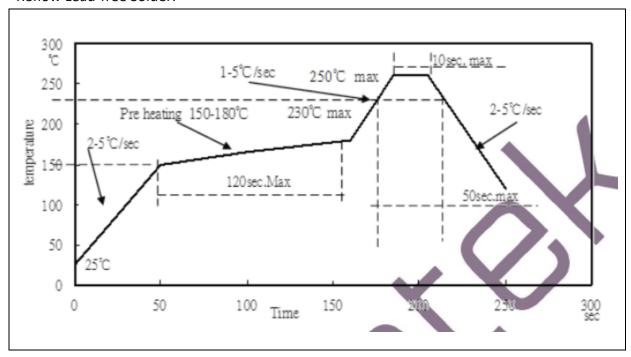






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



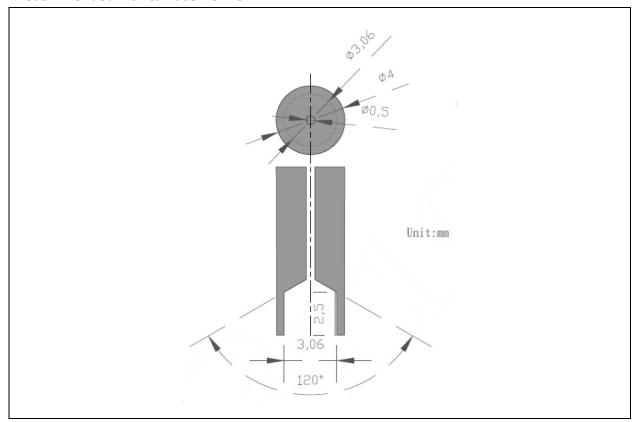
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. The recommended reflow temperature is 240°C. The maximum soldering temperature should be limited to 250°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



RECOMMENDED NOZZLE FOR SMT:

Recommended Pick & Place Nozzle:

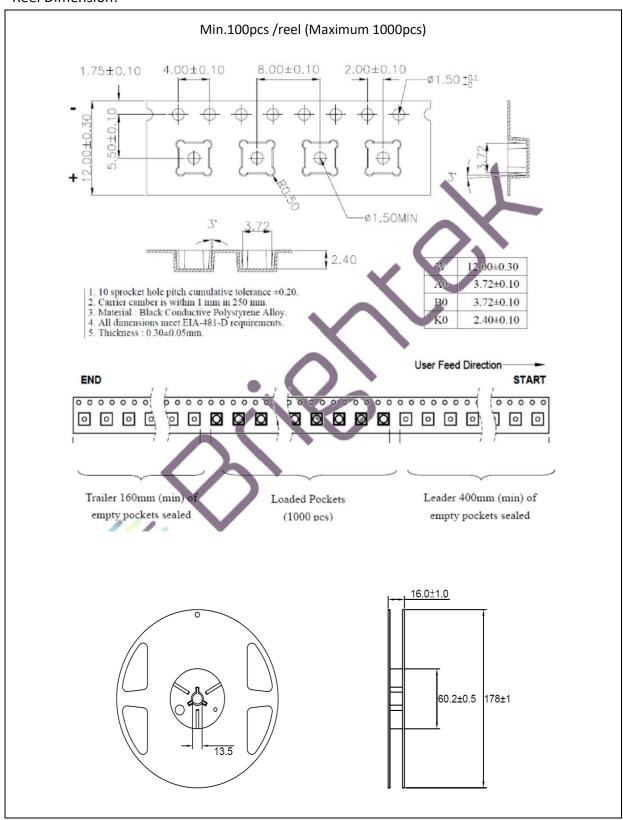


- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

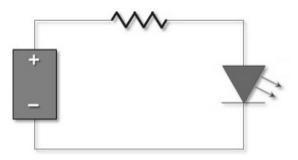
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	26/07/2014	Datasheet set-up.
A1.1	28/08/2014	Add starboard information.
A1.2	02/03/2015	Revised reel quantity.
A1.3	20/05/2016	Revise binning group.
A1.4	25/07/2018	Update outline height.